Kingbright

INFRARED EMITTING DIODE

Part Number: KM2520SF4C03

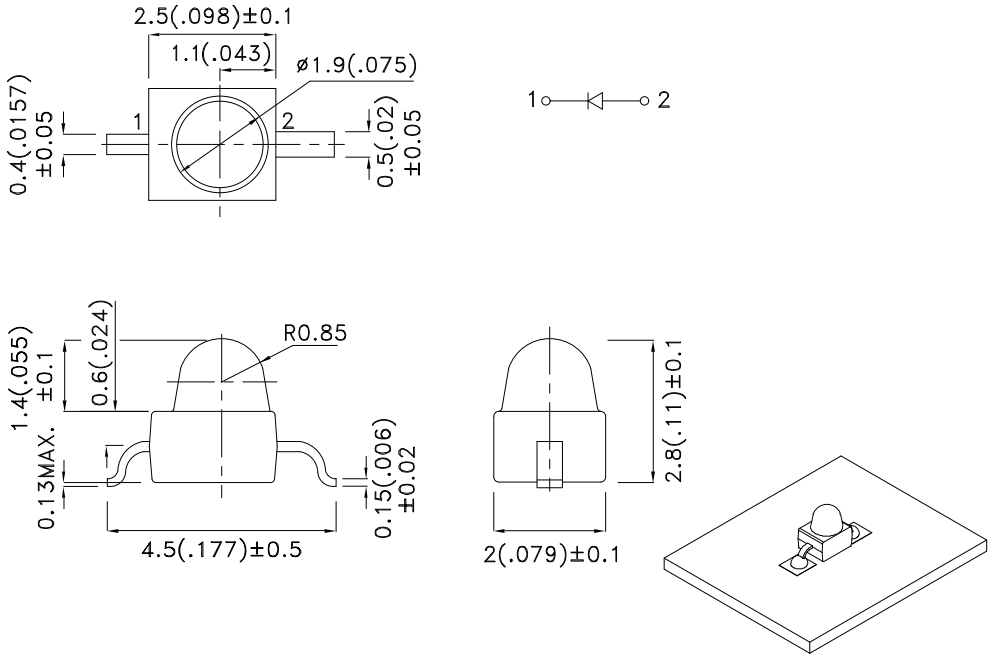
Features

- SUBMINIA TURE PACKAGE.
- MECHANICALLY AND SPECTRALLY MATCHED TO THE PHOTOTRANSISTOR.
- GULL WING LEAD.
- LONG LIFE - SOLID STATE RELIABILITY.
- LOW PACKAGE PROFILE.
- PACKAGE : 1000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

Description

SF4 Made with Gallium Aluminum Arsenide Infrared Emitting diodes.

Package Dimensions



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.
5. The device has a single mounting surface. The device must be mounted according to the specifications.

Selection Guide

Part No.	Dice	Lens Type	Po (mW/sr) [2] @ 20mA *50mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
KM2520SF4C03	SF4 (GaAlAs)	WATER CLEAR	1.6	4	20°
			*2.6	*8	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. * Luminous intensity with asterisk is measured at 50mA;Radiant Intensity/ luminous flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

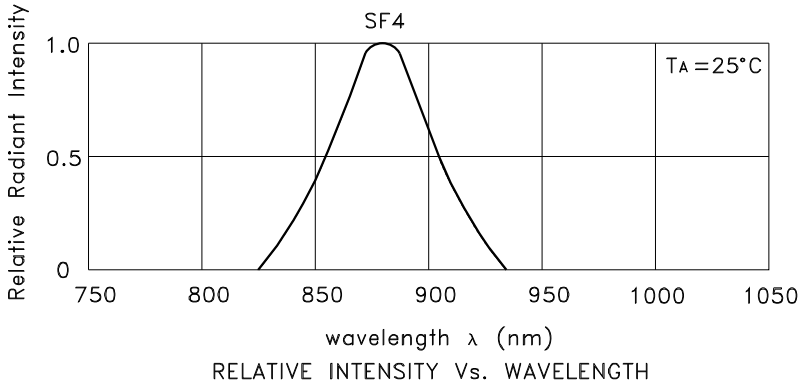
Parameter	P/N	Symbol	Typ.	Max.	Units	Test Conditions
Forward Voltage [1]	SF4	V_F	1.3	1.6	V	I_F=20mA
Reverse Current	SF4	I_R		10	uA	V_R = 5V
Capacitance	SF4	C	90		pF	V_F=0V;f=1MHz
Peak Spectral Wavelength	SF4	λP	880		nm	I_F=20mA
Spectral Bandwidth	SF4	Δλ1/2	50		nm	I_F=20mA

Note:
1. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

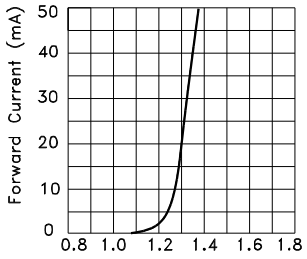
Parameter	Symbol	SF4	Units
Power dissipation	P_T	80	mW
DC Forward Current	I_F	50	mA
Peak Forward Current [1]	i_{FS}	1.2	A
Reverse Voltage	V_R	5	V
Operating Temperature	T_A	-40 To +85	°C
Storage Temperature	T_{STG}	-40 To +85	°C

Note:
1. 1/100 Duty Cycle, 10μs Pulse Width.

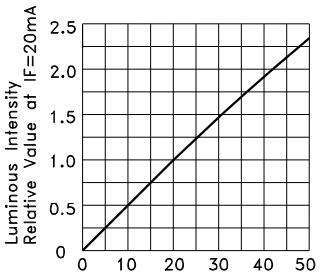


RELATIVE INTENSITY Vs. WAVELENGTH

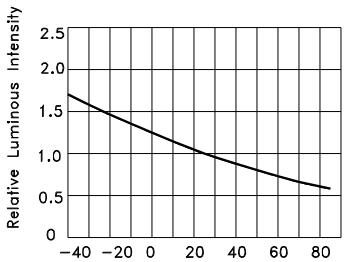
KM2520SF4C03



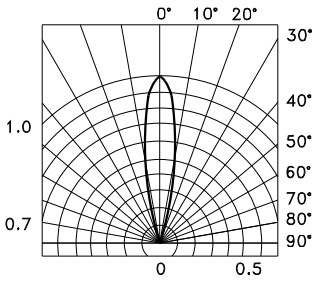
FORWARD CURRENT Vs.
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT



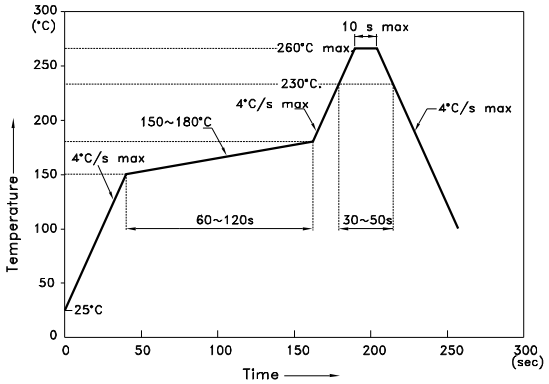
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

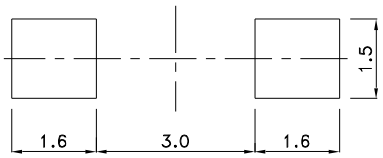
KM2520SF4C03

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:
1. We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.1)



Tape Specifications
(Units : mm)